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**INFORMATION DISCLOSURE  
STATEMENT BY APPLICANT**Sheet 1 of 2Application Number.: UnassignedFiling Date: HerewithFirst Named Inventor: Martin J. CrippenArt Unit: UnassignedExaminer Name: UnassignedAttorney Docket Number.: ROC920030321US1**U.S. PATENT DOCUMENTS**

Examiner Initials*	Cite No. <sup>1</sup>	Document Number Number - Kind Code <sup>2</sup> (if known)	Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Pages, Columns or Lines Where Relevant Passages or Figs. Appear
<i>U. J.</i>		US - 5754401A	05/19/1998	Mohsen Saneinejad et al	
<i>U. J.</i>		US - 6101094A	08/08/2000	Kaamel M. Kermaani et al	

**FOREIGN PATENT DOCUMENTS**

Examiner Initials	Cite No. <sup>1</sup>	Foreign Patent Document Country <sup>3</sup> - Number <sup>4</sup> - Kind Code <sup>5</sup> Code (if known)	Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Pages, Columns or Lines Where Relevant Passages or Figs. Appear	T <sup>6</sup>
<i>U. J.</i>		JP - 2000196269-A	07/14/2000	T. Kentaro		X

Examiner Signature	<i>U. J. Crippen</i>	Date Considered	11/17/05
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EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

<sup>1</sup> Applicant's unique citation designation number (optional). <sup>2</sup> See Kind Codes of USPTO Patent Documents at [www.uspto.gov](http://www.uspto.gov) or MPEP 901.04. <sup>3</sup> Enter Office that issued the document, by the two-letter code (WIPO Standard ST.3).

<sup>4</sup> For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document. <sup>5</sup> Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST.16 if possible. <sup>6</sup> Applicant is to place a check mark here if English language translation is attached.

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**INFORMATION DISCLOSURE  
STATEMENT BY APPLICANT**Sheet 2 of 2

Application Number.: Unassigned  
 Filing Date: Herewith  
 First Named Inventor: Martin J. Crippen  
 Art Unit: Unassigned  
 Examiner Name: Unassigned  
 Attorney Docket Number.: ROC920030321US1

**OTHER PRIOR ART - NON PATENT LITERATURE DOCUMENTS**

Examiner Initials	Cite No. <sup>1</sup>	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and or country where published.	T <sup>2</sup>
H. P.		US Publication 2003/0129863A1 published July 10, 2003, "Electronic Package With Thermally Conductive Standoff" by David J. Alcoe et al	
H. P.		IBM Technical Disclosure Bulletin, Vol. 7, No. 1, June 1964, page 113, "Heat Conducting Vibration and Shock Mount" by M. C. Panaro	
H. P.		IBM Technical Disclosure Bulletin, Vol. 24, No. 5, October 1981, pp. 2534-2535, "Flip Chip Heat Sink" by A. H. Bauman and D. G. Peterson	
H. P.		IBM Technical Disclosure Bulletin, Vol. 29, No. 11, April 1987, pp. 4950-4951, "Thermal Sponge" by S. K. Kang, P. G. Ledermann and P. A. Moskowitz	

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